506479449 02/01/2021

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6526225

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
BHUSHAN ZOPE	09/04/2018
KIRAN SHRESTHA	08/21/2018
SHANKAR SWAMINATHAN	09/06/2018
CHIYU ZHU	10/21/2020
HENRI TUOMAS ANTERO JUSSILA	08/22/2018
QI XIE	08/21/2018

RECEIVING PARTY DATA

Name:	ASM IP HOLDING B.V.
Street Address:	VERSTERKERSTRAAT 8
City:	ALMERE
State/Country:	NETHERLANDS
Postal Code:	1322 AP

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	17151435

CORRESPONDENCE DATA

Fax Number: (602)382-6070

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

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Email: ipdocket@swlaw.com

Correspondent Name: SNELL & WILMER L.L.P.

Address Line 1: 400 EAST VAN BUREN STREET, SUITE 1900

Address Line 2: ONE ARIZONA CENTER

Address Line 4: PHOENIX, ARIZONA 85004-2202

ATTORNEY DOCKET NUMBER: 81048.11717

NAME OF SUBMITTER: ROBERT A. CLARKE

SIGNATURE: /Robert A. Clarke/

DATE SIGNED: 02/01/2021

PATENT 506479449 REEL: 055094 FRAME: 0988

Total Attachments: 10

source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page1.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page2.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page3.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page4.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page5.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page6.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page7.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page8.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page9.tif source=PAT-AM-0896-US-NP Notice of Recordation of Assignment dtd 11-7-2020#page9.tif

PATENT REEL: 055094 FRAME: 0989



UNITED STATES PATENT AND TRADEMARK OFFICE

UNDER SECRETARY OF COMMERCE FOR INTELLECTUAL PROPERTY AND DIRECTOR OF THE UNITED STATES PATENT AND TRADEMARK OFFICE

NOVEMBER 10, 2020

PTAS

PATRICK LEE 3440 E. UNIVERSITY DRIVE PHOENIX, AZ 85034 506343331

UNITED STATES PATENT AND TRADEMARK OFFICE NOTICE OF RECORDATION OF ASSIGNMENT DOCUMENT

THE ENCLOSED DOCUMENT HAS BEEN RECORDED BY THE ASSIGNMENT RECORDATION BRANCH OF THE U.S. PATENT AND TRADEMARK OFFICE. A COMPLETE COPY IS AVAILABLE AT THE ASSIGNMENT SEARCH ROOM ON THE REEL AND FRAME NUMBER REFERENCED BELOW.

PLEASE REVIEW ALL INFORMATION CONTAINED ON THIS NOTICE. THE INFORMATION CONTAINED ON THIS RECORDATION NOTICE REFLECTS THE DATA PRESENT IN THE PATENT AND TRADEMARK ASSIGNMENT SYSTEM. IF YOU SHOULD FIND ANY ERRORS OR HAVE QUESTIONS CONCERNING THIS NOTICE, YOU MAY CONTACT THE ASSIGNMENT RECORDATION BRANCH AT 571-272-3350. PLEASE SEND REQUEST FOR CORRECTION TO: U.S. PATENT AND TRADEMARK OFFICE, MAIL STOP: ASSIGNMENT RECORDATION BRANCH, P.O. BOX 1450, ALEXANDRIA, VA 22313.

RECORDATION DATE: 11/07/2020 REEL/FRAME: 054306/0355

NUMBER OF PAGES: 9

BRIEF: ASSIGNMENT OF ASSIGNORS INTEREST (SEE DOCUMENT FOR DETAILS).

DOCKET NUMBER: PAT-AM-0896-US-NP

ASSIGNOR:

BHUSHAN, ZOPE DOC DATE: 09/04/2018

ASSIGNOR:

SHRESTHA, KIRAN DOC DATE: 08/21/2018

ASSIGNOR:

SWAMINATHAN, SHANKAR DOC DATE: 09/06/2018

ASSIGNOR:

ZHU, CHIYU DOC DATE: 10/21/2020

ASSIGNOR:

JUSSILA, HENRI TUOMAS ANTERO DOC DATE: 08/22/2018

ASSIGNOR:

XIE, QI DOC DATE: 08/21/2018

ASSIGNEE:

ASM IP HOLDING B.V. VERSTERKERSTRAAT 8 ALMERE, NETHERLANDS 1322 AP

APPLICATION NUMBER: 16105802 FILING DATE: 08/20/2018

PATENT NUMBER: ISSUE DATE:

TITLE: METHODS FOR DEPOSITING A MOLYBDENUM METAL FILM OVER A DIELECTRIC

SURFACE OF A SUBSTRATE BY A CYCLICAL DEPOSITION PROCESS AND

RELATED SEMICONDUCTOR DEVICE STRUCTURES

ASSIGNMENT RECORDATION BRANCH PUBLIC RECORDS DIVISION

PATENT REEL: 055094 FRAME: 0991

PATENT ASSIGNMENT COVER SHEET

Electronic Version v1.1 Stylesheet Version v1.2 EPAS ID: PAT6390085

SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
ZOPE BHUSHAN	09/04/2018
KIRAN SHRESTHA	08/21/2018
SHANKAR SWAMINATHAN	09/06/2018
CHIYU ZHU	10/21/2020
HENRI TUOMAS ANTERO JUSSILA	08/22/2018
QI XIE	08/21/2018

RECEIVING PARTY DATA

Name:	ASM IP HOLDING B.V.
Street Address:	VERSTERKERSTRAAT 8
City:	ALMERE
State/Country:	NETHERLANDS
Postal Code:	1322 AP

PROPERTY NUMBERS Total: 1

***************************************	Property Type	Number
	Application Number:	16105802

CORRESPONDENCE DATA

Fax Number: (602)470-2434

Correspondence will be sent to the e-mail address first; if that is unsuccessful, it will be sent

using a fax number, if provided; if that is unsuccessful, it will be sent via US Mail.

Phone: 6024705707

Email: michelle.sympson@asm.com

Correspondent Name: PATRICK LEE

Address Line 1: 3440 E. UNIVERSITY DRIVE
Address Line 4: PHOENIX, ARIZONA 85034

ATTORNEY DOCKET NUMBER:	PAT-AM-0896-US-NP
NAME OF SUBMITTER:	MICHELLE SYMPSON
SIGNATURE:	/Michelle Sympson/
DATE SIGNED:	11/07/2020

Total Attachments: 7

PATENT REEL: 055094 FRAME: 0992 Application Serial No.: 16/105,802 Docket No.: PAT-AM-0896-US-NP

Filing Date: August 20, 2018

Title: METHODS FOR DEPOSITING A MOLYBDENUM METAL FILM OVER A DIELECTRIC SURFACE OF A SUBSTRATE BY A CYCLICAL DEPOSITION PROCESS

AND RELATED SEMICONDUCTOR DEVICE STRUCTURES

ASSIGNMENT

WHEREAS, BHUSHAN ZOPE, a citizen of India and a resident of Phoenix, Arizona; KIRAN SHRESTHA, a citizen of Nepal and a resident of Tempe, Arizona; SHANKAR SWAMINATHAN, a citizen of India and a resident of Phoenix, Arizona; CHIYU ZHU, a citizen of China and a resident of Helsinki, Finland; HENRI TUOMAS ANTERO JUSSILA, a citizen of Finland and a resident of Espoo, Finland; and QI XIE, a citizen of Belgium and a resident of Leuven, Belgium;

(collectively, "WE" or "ASSIGNOR") have conceived of one or more processes, methods, machines, articles of manufacture, designs, compositions of matter, inventions, discoveries or new or useful improvements relating to METHODS FOR DEPOSITING A MOLYBDENUM METAL FILM OVER A DIELECTRIC SURFACE OF A SUBSTRATE BY A CYCLICAL DEPOSITION PROCESS AND RELATED SEMICONDUCTOR DEVICE STRUCTURES (collectively, the "INVENTIONS") for which WE have executed and/or may execute one or more patent applications therefore; and

WHEREAS, ASM IP HOLDING B.V. (hereinafter "ASSIGNEE"), a corporation having a place of business at Versterkerstaat 8, Almere, 1322 AP, Netherlands, desires to acquire or otherwise obtain the entire right, title, and interest in and to said INVENTIONS, including all patent applications therefore, and all patents that have granted or may be granted hereafter thereon, including, but not limited to, those identified below.

NOW, THEREFORE, for good and valuable consideration, the receipt of which is hereby acknowledged, WE do hereby acknowledge that WE have sold, assigned, conveyed and transferred, and by these presents do hereby sell, assign, convey and transfer, unto ASSIGNEE, its successors, its legal representatives and its assigns, the entire right, title, and interest throughout the world in and to said INVENTIONS, including all patent applications therefore that may have been filed or may be filed hereafter for said INVENTIONS (including but not limited Application No(s). 16/105,802, filed on August 20, 2018, as Docket No. PAT-AM-0896-US-NP (and do hereby authorize ASSIGNEE and its representative to hereafter add herein such application number(s) and/or filing date(s) when known)) and all rights of priority under International Conventions, Treaties, and Agreements, all utility applications, national phase applications, utility model applications, divisional applications, renewal applications, continuation applications, validation applications and design applications thereof,

and all issued patents which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon;

AND WE DO HEREBY authorize and request any Official of any country or countries whose duty it is to issue patents on applications or registrations, to issue all patents for said INVENTIONS to ASSIGNEE, its successors, its legal representatives, and its assigns, in accordance with the terms of this instrument:

AND WE DO HEREBY sell, assign, transfer, and convey to said ASSIGNEE, its successors, its legal representatives, and its assigns all claims for damages and all remedies arising out of or relating to any violation(s) of any of the rights assigned hereby that have or may have accrued prior to the date of assignment to said ASSIGNEE, or may accrue hereafter, including, but not limited to the right to sue for, seek, obtain, collect, recover and retain damages and any ongoing or prospective royalties to which WE may be entitled, or form any settlement or agreement related to any of said patents before or after issuance;

AND WE HEREBY covenant and agree that WE will communicate promptly to said ASSIGNEE, its successors, its legal representatives, and its assigns, any facts known to us respecting said INVENTIONS, and will testify in any legal proceeding, sign all lawful papers, execute all applications and certificates, make all rightful declarations and/or oaths, and provide all lawful assistance to said ASSIGNEE, its successors, its legal representatives, and its assigns, to obtain and enforce patent protection for said INVENTIONS in all countries.

EXECUTED as of the date(s) below by ASSIGNOR:

ZOPE BHUSHAN	
1392°	4/4/18
Signature	Date
KIRAN SHRESTHA	
Signature	Date
SHANKAR SWAMINATHAN	
Signature	Date
CHIYU ZHU	
Signature	Date

and all issued patents which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon;

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EXECUTED as of the date(s) below by ASSIGNOR:

ZOPE BHUSHAN	
Signature	Date
KIRAN SHRESTHA	08-21-2018
Signature	Date
SHANKAR SWAMINATHAN	
Signature	Date
CHIYU ZHU	
	** ***********************************
Signature	Date

and all issued patents which may have granted or may be granted hereafter thereon and all reissues, renewals, reexaminations, and extensions to any of the foregoing and all patents issuing thereon;

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EXECUTED as of the date(s) below by ASSIGNOR:

ZOPE BHUSHAN	
Signature	Date
KIRAN SHRESTHA	
Signature	Date
SHANKAR SWAMINATHAN	9/6/2018
Signature	Date
CHIYU ZHU	
Signature	Date

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EXECUTED as of the date(s) below by ASSIGNOR:

ZOPE BHUSHAN	
Signature	Date
KIRAN SHRESTHA	
Signature	Date
SHANKAR SWAMINATHAN	
Signature	Date
CHIYU ZHU	Oct 21 2020
Signature	Date

HENRI TUOMAS ANTERO JUSSILA	22.8.2018
Signature	Date
QI XIE	
Signature	Date

HENRI TUOMAS ANTERO JUSSILA	
Signature	Date
QI XIE	August 21, 2018
Signature	Date

Page 3 of 3